

Dual D Flip-Flop with Set and Reset Positive-Edge Trigger

Features

- **Hysteresis on Clock Inputs for Improved Noise Immunity and Increased Input Rise and Fall Times**
- **Asynchronous Set and Reset**
- **Complementary Outputs**
- **Buffered Inputs**
- **Typical $f_{MAX} = 50\text{MHz}$ at $V_{CC} = 5\text{V}$, $C_L = 15\text{pF}$, $T_A = 25^\circ\text{C}$**
- **Fanout (Over Temperature Range)**
 - Standard Outputs **10 LSTTL Loads**
 - Bus Driver Outputs **15 LSTTL Loads**
- **Wide Operating Temperature Range . . . -55°C to 125°C**
- **Balanced Propagation Delay and Transition Times**
- **Significant Power Reduction Compared to LSTTL Logic ICs**
- **HC Types**
 - **2V to 6V Operation**
 - **High Noise Immunity: $N_{IL} = 30\%$, $N_{IH} = 30\%$ of V_{CC} at $V_{CC} = 5\text{V}$**
- **HCT Types**
 - **4.5V to 5.5V Operation**
 - **Direct LSTTL Input Logic Compatibility, $V_{IL} = 0.8\text{V}$ (Max), $V_{IH} = 2\text{V}$ (Min)**
 - **CMOS Input Compatibility, $I_I \leq 1\mu\text{A}$ at V_{OL} , V_{OH}**

Description

The 'HC74 and 'HCT74 utilize silicon gate CMOS technology to achieve operating speeds equivalent to LSTTL parts. They exhibit the low power consumption of standard CMOS integrated circuits, together with the ability to drive 10 LSTTL loads.

This flip-flop has independent DATA, $\overline{\text{SET}}$, $\overline{\text{RESET}}$ and CLOCK inputs and Q and $\overline{\text{Q}}$ outputs. The logic level present at the data input is transferred to the output during the positive-going transition of the clock pulse. SET and RESET are independent of the clock and are accomplished by a low level at the appropriate input.

The HCT logic family is functionally as well as pin compatible with the standard LS logic family.

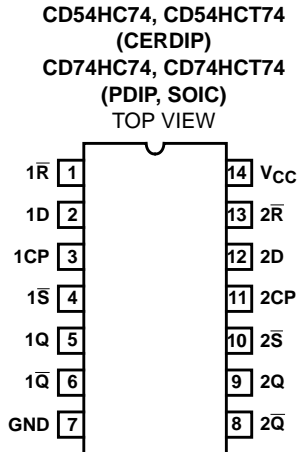
Ordering Information

| PART NUMBER | TEMP. RANGE (°C) | PACKAGE |
|--------------|------------------|--------------|
| CD54HC74F3A | -55 to 125 | 14 Ld CERDIP |
| CD54HCT74F3A | -55 to 125 | 14 Ld CERDIP |
| CD74HC74E | -55 to 125 | 14 Ld PDIP |
| CD74HC74M | -55 to 125 | 14 Ld SOIC |
| CD74HC74MT | -55 to 125 | 14 Ld SOIC |
| CD74HC74M96 | -55 to 125 | 14 Ld SOIC |
| CD74HCT74E | -55 to 125 | 14 Ld PDIP |
| CD74HCT74M | -55 to 125 | 14 Ld SOIC |
| CD74HCT74MT | -55 to 125 | 14 Ld SOIC |
| CD74HCT74M96 | -55 to 125 | 14 Ld SOIC |

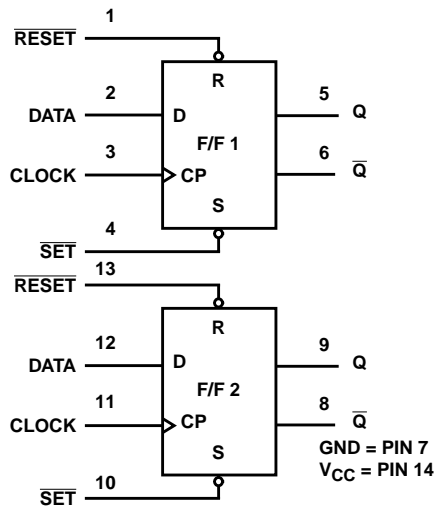
NOTE: When ordering, use the entire part number. The suffix 96 denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

CD54HC74, CD74HC74, CD54HCT74, CD74HCT74

Pinout



Functional Diagram



TRUTH TABLE

| INPUTS | | | | OUTPUTS | |
|--------|-------|----|---|----------------|-----------------|
| SET | RESET | CP | D | Q | Q̄ |
| L | H | X | X | H | L |
| H | L | X | X | L | H |
| L | L | X | X | H (Note 1) | H (Note 1) |
| H | H | ↑ | H | H | L |
| H | H | ↑ | L | L | H |
| H | H | L | X | Q ₀ | Q̄ ₀ |

H= High Level (Steady State)

L= Low Level (Steady State)

X= Don't Care

↑= Low-to-High Transition

Q₀ = the level of Q before the indicated input conditions were established.

NOTE:

1. This configuration is nonstable, that is, it will not persist when set and reset inputs return to their inactive (high) level.

CD54HC74, CD74HC74, CD54HCT74, CD74HCT74

Absolute Maximum Ratings

| | |
|--|-------------|
| DC Supply Voltage, V_{CC} | -0.5V to 7V |
| DC Input Diode Current, I_{IK} | |
| For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ | $\pm 20mA$ |
| DC Drain Current, per Output, I_O | |
| For $-0.5V < V_O < V_{CC} + 0.5V$ | $\pm 25mA$ |
| DC Output Diode Current, I_{OK} | |
| For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ | $\pm 20mA$ |
| DC Output Source or Sink Current per Output Pin, I_O | |
| For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ | $\pm 25mA$ |
| DC V_{CC} or Ground Current, I_{CC} | $\pm 50mA$ |

Thermal Information

| | |
|--|------------------------------------|
| Thermal Resistance (Typical, Note 2) | θ_{JA} ($^{\circ}C/W$) |
| E (PDIP) Package | 80 |
| M (SOIC) Package | 86 |
| Maximum Junction Temperature (Hermetic Package or Die) . . . | 175 $^{\circ}C$ |
| Maximum Junction Temperature (Plastic Package) | 150 $^{\circ}C$ |
| Maximum Storage Temperature Range | -65 $^{\circ}C$ to 150 $^{\circ}C$ |
| Maximum Lead Temperature (Soldering 10s) | 300 $^{\circ}C$ |
| (SOIC - Lead Tips Only) | |

Operating Conditions

| | |
|--|------------------------------------|
| Temperature Range (T_A) | -55 $^{\circ}C$ to 125 $^{\circ}C$ |
| Supply Voltage Range, V_{CC} | |
| HC Types | .2V to 6V |
| HCT Types | 4.5V to 5.5V |
| DC Input or Output Voltage, V_I, V_O | 0V to V_{CC} |
| Input Rise and Fall Time | |
| 2V | 1000ns (Max) |
| 4.5V | 500ns (Max) |
| 6V | 400ns (Max) |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

- The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

| PARAMETER | SYMBOL | TEST CONDITIONS | | V_{CC} (V) | 25 $^{\circ}C$ | | | -40 $^{\circ}C$ TO 85 $^{\circ}C$ | | -55 $^{\circ}C$ TO 125 $^{\circ}C$ | | UNITS | |
|---|----------|-------------------------|------------|--------------|----------------|------|-----------|-----------------------------------|---------|------------------------------------|---------|---------|---|
| | | V_I (V) | I_O (mA) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | | |
| HC TYPES | | | | | | | | | | | | | |
| High Level Input Voltage | V_{IH} | - | - | 2 | 1.5 | - | - | 1.5 | - | 1.5 | - | V | |
| | | | | 4.5 | 3.15 | - | - | 3.15 | - | 3.15 | - | V | |
| | | | | 6 | 4.2 | - | - | 4.2 | - | 4.2 | - | V | |
| Low Level Input Voltage | V_{IL} | - | - | 2 | - | - | 0.5 | - | 0.5 | - | 0.5 | V | |
| | | | | 4.5 | - | - | 1.35 | - | 1.35 | - | 1.35 | V | |
| | | | | 6 | - | - | 1.8 | - | 1.8 | - | 1.8 | V | |
| High Level Output Voltage CMOS Loads | V_{OH} | V_{IH} or V_{IL} | -0.02 | 2 | 1.9 | - | - | 1.9 | - | 1.9 | - | V | |
| | | | | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V | |
| | | | | 6 | 5.9 | - | - | 5.9 | - | 5.9 | - | V | |
| High Level Output Voltage TTL Loads | V_{OH} | V_{IH} or V_{IL} | - | - | - | - | - | - | - | - | - | V | |
| | | | | -4 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| | | | | -5.2 | 6 | 5.48 | - | - | 5.34 | - | 5.2 | - | V |
| Low Level Output Voltage CMOS Loads | V_{OL} | V_{IH} or V_{IL} | 0.02 | 2 | - | - | 0.1 | - | 0.1 | - | 0.1 | V | |
| | | | | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V | |
| | | | | 6 | - | - | 0.1 | - | 0.1 | - | 0.1 | V | |
| Low Level Output Voltage TTL Loads | V_{OL} | V_{IH} or V_{IL} | - | - | - | - | - | - | - | - | - | V | |
| | | | | 4 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| | | | | 5.2 | 6 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| Input Leakage Current | I_I | V_{CC} or GND | - | 6 | - | - | ± 0.1 | - | ± 1 | - | ± 1 | μA | |

CD54HC74, CD74HC74, CD54HCT74, CD74HCT74

DC Electrical Specifications (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|--|---------------------------|------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|-----|-------|
| | | V _I (V) | I _O (mA) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| Quiescent Device Current | I _{CC} | V _{CC} or GND | 0 | 6 | - | - | 4 | - | 40 | - | 80 | μA |
| HCT TYPES | | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 4.5 to 5.5 | 2 | - | - | 2 | - | 2 | - | V |
| Low Level Input Voltage | V _{IL} | - | - | 4.5 to 5.5 | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| High Level Output Voltage CMOS Loads | V _{OH} | V _{IH} or V _{IL} | -0.02 | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V |
| High Level Output Voltage TTL Loads | | | -4 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| Low Level Output Voltage CMOS Loads | V _{OL} | V _{IH} or V _{IL} | 0.02 | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| Low Level Output Voltage TTL Loads | | | 4 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| Input Leakage Current | I _I | V _{CC} and GND | - | 5.5 | - | | ±0.1 | - | ±1 | - | ±1 | μA |
| Quiescent Device Current | I _{CC} | V _{CC} or GND | 0 | 5.5 | - | - | 4 | - | 40 | - | 80 | μA |
| Additional Quiescent Device Current Per Input Pin: 1 Unit Load | ΔI _{CC} (Note 3) | V _{CC} - 2.1 | - | 4.5 to 5.5 | - | 100 | 360 | - | 450 | - | 490 | μA |

NOTE:

3. For dual-supply systems theoretical worst case (V_I = 2.4V, V_{CC} = 5.5V) specification is 1.8mA.

HCT Input Loading Table

| INPUT | UNIT LOADS |
|-----------|------------|
| D | 0.5 |
| \bar{R} | 0.5 |
| CP | 0.7 |
| \bar{S} | 0.75 |

NOTE: Unit Load is ΔI_{CC} limit specified in DC Electrical Specifications table, e.g., 360μA max at 25°C.

Prerequisite For Switching Specifications

| PARAMETER | SYMBOL | TEST CONDITIONS | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|----------------------------------|-----------------|-----------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| HC TYPES | | | | | | | | | | | |
| Data to CP Setup Time (Figure 5) | t _{SU} | - | 2 | 60 | - | - | 75 | - | 90 | - | ns |
| | | | 4.5 | 12 | - | - | 15 | - | 18 | - | ns |
| | | | 6 | 10 | - | - | 13 | - | 15 | - | ns |

CD54HC74, CD74HC74, CD54HCT74, CD74HCT74

Prerequisite For Switching Specifications (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|---|------------------|-----------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| Hold Time (Figure 5) | t _H | - | 2 | 3 | - | - | 3 | - | 3 | - | ns |
| | | | 4.5 | 3 | - | - | 3 | - | 3 | - | ns |
| | | | 6 | 3 | - | - | 3 | - | 3 | - | ns |
| Removal Time \bar{R} , \bar{S} , to CP (Figure 5) | t _{REM} | - | 2 | 30 | - | - | 40 | - | 45 | - | ns |
| | | | 4.5 | 6 | - | - | 8 | - | 9 | - | ns |
| | | | 6 | 5 | - | - | 7 | - | 8 | - | ns |
| Pulse Width \bar{R} , \bar{S} (Figure 1) | t _W | - | 2 | 80 | - | - | 100 | - | 120 | - | ns |
| | | | 4.5 | 16 | - | - | 20 | - | 24 | - | ns |
| | | | 6 | 14 | - | - | 17 | - | 20 | - | ns |
| Pulse Width CP (Figure 1) | t _W | - | 2 | 80 | - | - | 100 | - | 120 | - | ns |
| | | | 4.5 | 16 | - | - | 20 | - | 24 | - | ns |
| | | | 6 | 14 | - | - | 17 | - | 20 | - | ns |
| CP Frequency | f _{MAX} | - | 2 | 6 | - | - | 5 | - | 4 | - | MHz |
| | | | 4.5 | 30 | - | - | 25 | - | 20 | - | MHz |
| | | | 6 | 35 | - | - | 29 | - | 23 | - | MHz |

HCT TYPES

| | | | | | | | | | | | |
|---|------------------|---|-----|----|---|---|----|---|----|---|-----|
| Data to CP Setup Time (Figure 6) | t _{SU} | - | 4.5 | 12 | - | - | 15 | - | 18 | - | ns |
| Hold Time (Figure 6) | t _H | - | 4.5 | 3 | - | - | 3 | - | 3 | - | ns |
| Removal Time \bar{R} , \bar{S} , to CP (Figure 6) | t _{REM} | - | 4.5 | 6 | - | - | 8 | - | 9 | - | ns |
| Pulse Width \bar{R} , \bar{S} (Figure 2) | t _W | - | 4.5 | 16 | - | - | 20 | - | 24 | - | ns |
| Pulse Width CP (Figure 2) | t _W | - | 4.5 | 18 | - | - | 23 | - | 27 | - | ns |
| CP Frequency | f _{MAX} | - | 4.5 | 25 | - | - | 20 | - | 16 | - | MHz |

Switching Specifications Input t_p, t_f = 6ns

| PARAMETER | SYMBOL | TEST CONDITIONS | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|---|-------------------------------------|-----------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| HC TYPES | | | | | | | | | | | |
| Propagation Delay, CP to Q, \bar{Q} (Figure 3) | t _{PLH} , t _{PHL} | C _L = 50pF | 2 | - | - | 175 | - | 220 | - | 265 | ns |
| | | C _L = 50pF | 4.5 | - | - | 35 | - | 44 | - | 53 | ns |
| | | C _L = 15pF | 5 | - | 14 | - | - | - | - | - | ns |
| | | C _L = 50pF | 6 | - | - | 30 | - | 37 | - | 45 | ns |
| Propagation Delay, \bar{R} , \bar{S} to Q, \bar{Q} (Figure 3) | t _{PLH} , t _{PHL} | C _L = 50pF | 2 | - | - | 200 | - | 250 | - | 300 | ns |
| | | C _L = 50pF | 4.5 | - | - | 40 | - | 50 | - | 60 | ns |
| | | C _L = 15pF | 5 | - | 17 | - | - | - | - | - | ns |
| | | C _L = 50pF | 6 | - | - | 34 | - | 43 | - | 51 | ns |
| Transition Time (Figure 3) | t _{TLH} , t _{THL} | C _L = 50pF | 2 | - | - | 75 | - | 95 | - | 110 | ns |
| | | C _L = 50pF | 4.5 | - | - | 15 | - | 19 | - | 22 | ns |
| | | C _L = 50pF | 6 | - | - | 13 | - | 16 | - | 19 | ns |
| Input Capacitance | C _I | - | - | - | - | 10 | - | 10 | - | 10 | pF |

CD54HC74, CD74HC74, CD54HCT74, CD74HCT74

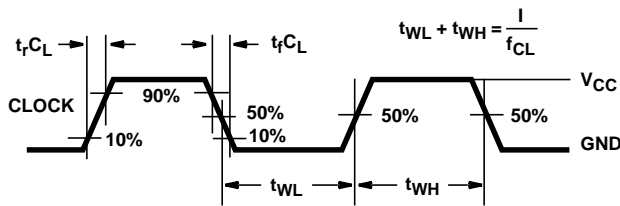
Switching Specifications Input $t_r, t_f = 6\text{ns}$ (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | V_{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|---|--------------------|---------------------|-----------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| CP Frequency | f_{MAX} | $C_L = 15\text{pF}$ | 5 | - | 50 | - | - | - | - | - | MHz |
| Power Dissipation Capacitance (Notes 4, 5) | C_{PD} | - | 5 | - | 25 | - | - | - | - | - | pF |
| HCT TYPES | | | | | | | | | | | |
| Propagation Delay, CP to Q, \bar{Q} (Figure 4) | t_{PLH}, t_{PHL} | $C_L = 50\text{pF}$ | 4.5 | - | - | 35 | - | 44 | - | 53 | ns |
| Propagation Delay, R, S to Q, Q (Figure 4) | t_{PHL}, t_{PLH} | $C_L = 50\text{pF}$ | 4.5 | - | - | 40 | - | 50 | - | 60 | ns |
| Transition Time (Figure 4) | t_{TLH}, t_{THL} | $C_L = 50\text{pF}$ | 4.5 | - | - | 15 | - | 19 | - | 22 | ns |
| Input Capacitance | C_I | - | - | - | - | 10 | - | 10 | - | 10 | pF |
| CP Frequency | f_{MAX} | $C_L = 15\text{pF}$ | 5 | - | 50 | - | - | - | - | - | MHz |
| Power Dissipation Capacitance (Notes 4, 5) | C_{PD} | - | 5 | - | 30 | - | - | - | - | - | pF |

NOTES:

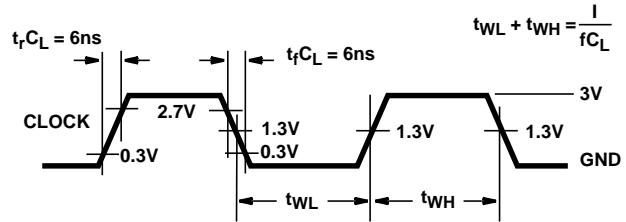
- C_{PD} is used to determine the dynamic power consumption, per flip-flop.
- $P_D = C_{PD} V_{CC}^2 f_i + \sum (C_L V_{CC}^2 f_o)$ where f_i = input frequency, f_o = output frequency, C_L = output load capacitance, V_{CC} = supply voltage.

Test Circuits and Waveforms



NOTE: Outputs should be switching from 10% V_{CC} to 90% V_{CC} in accordance with device truth table. For f_{MAX} , input duty cycle = 50%.

FIGURE 1. HC CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH



NOTE: Outputs should be switching from 10% V_{CC} to 90% V_{CC} in accordance with device truth table. For f_{MAX} , input duty cycle = 50%.

FIGURE 2. HCT CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH

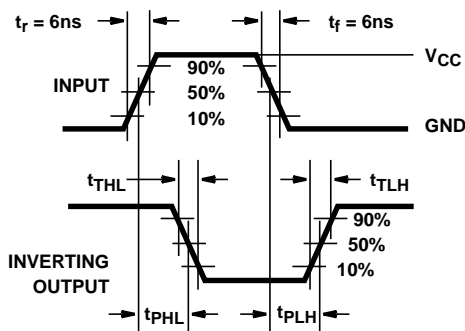


FIGURE 3. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

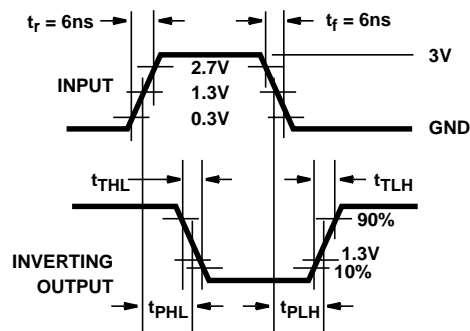


FIGURE 4. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

Test Circuits and Waveforms (Continued)



FIGURE 5. HC SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS



FIGURE 6. HCT SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS